ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES	Material Composit © Copyright 2005. IPC, 1 international and Pan-Am	Bannockb	urn, Illinois. A	ll rights reserved untions.	under both	This docum level parts,	ent is a decla	ration of	f the substances	s within the manufactu er level materials for v	rer listed which the r	item. Note: i nanufacture	if the item is an as r has engineering	ssembly with lower responsibility.	
1752-21.1	IPC Web Site for Information on IPC-1752 Standard http://www.ipc.org/IPC-175x				Form Type * Distribute			Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials and Mfg Information							
Supplier Informa	ation														
Company name*			Company unique ID			Unique ID Authority				Respon	Response Date*				
onsemi											2023-06	2023-06-08			
Contact Name			Title - Contact			Phone - Contact*				Email -	Email - Contact*				
Product-Env-Stewards			Product Enviro Compliance			NA				Produ	Product-Env-Stewards@onsemi.com				
Authorized Representative*			Title - Representative			Phone - Representative*			Email -	Email - Representative*					
Product-Env-Stewards			Product Enviro Compliance			NA				Produ	Product-Env-Stewards@onsemi.com				
Requester	Requester Item Number Mfr Item		Number Mfr Item Name				Effective D	ate Ve	ersion	Manufacturing Site		Weight*	UOM	Unit Type	
		CAT5221WI-00-T1		DPP NV, QUAD 64 TAPS, I2C			2023-06-08	;		PH1		505.08	mg	Each	
Manufacturing P	Proccess Information	1		·									·		
Terminal Plating / Grid Array Material Termin			erminal Base A	al Base Alloy J-STD-020 MSL		L Rating	Peak P	Peak Process Body Temperatu		ure Max Time at Peak Tempera		ture Numb	ber of Reflow Cy	cles	
Matte Tin (Sn) - annealed CU Allo			U Alloy	loy 3			260 C 30			seconds 3					
Comments															
ATTENTION: MSL	3 Rated item requires Ba	ke and D	ry Pack (after	electrical test)											
For more information	n regarding material com	position p	please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU		nium (Cr6+), Polybro	mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl iisobutyl phthalate (DIBP).								
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of						
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	on above	Supplier Acceptance	* Accepted							
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.											
Supplier Digital Signature Ra	stislav Drska	Le									

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	7.86	mg	Supplier	Silicon (Si)	7440-21-3		7.86	mg
Die Attach	0.91	mg	Supplier	Silver (Ag)	7440-22-4		0.6825	mg
			Supplier	Epoxy resins	129915-35-1		0.2275	mg
Lead Frame	125.32	mg	Supplier	Silver (Ag)	7440-22-4		0.7645	mg
			Supplier	Zinc (Zn)	7440-66-6		0.1504	mg
			Supplier	Iron (Fe)	7439-89-6		2.945	mg
			Supplier	Copper (Cu)	7440-50-8		121.4225	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0376	mg
Mold Compound-Black	367.12	mg		Epoxy Phenol Resin	proprietary data		38.5476	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		328.5724	mg
Plating	3.46	mg	Supplier	Tin (Sn)	7440-31-5		3.46	mg
Wire Bond - Au	0.41	mg	Supplier	Gold (Au)	7440-57-5		0.41	mg